

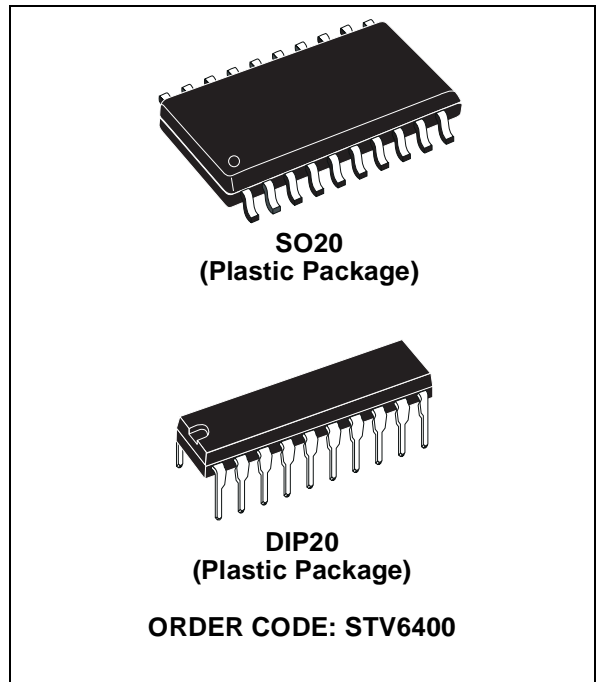
## DOUBLE SCART INTERFACE

- Two Periplugs I/O Source Management
- Two 150Ω Integrated Buffers for Plug Drive
- One Output with Muting Capability
- 3 Digital Buffer Outputs for external Switches Control
- Large Supply Voltage Range
- Bandwidth : 19 MHz typ.
- Crosstalk : 50 dB (Min.)
- I<sup>2</sup>C Bus Control

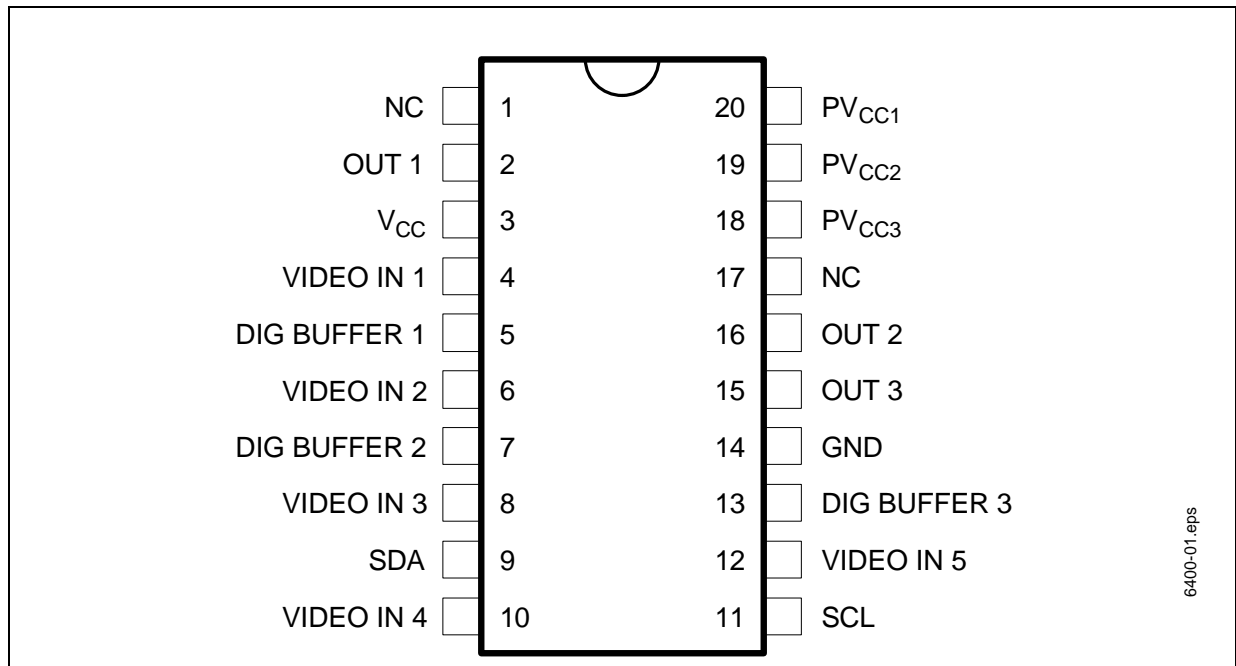
### DESCRIPTION

The STV6400 is a bipolar circuit for TV and VCR applications.

It is intended to process all switches relating to a 2 periplugs I/O application

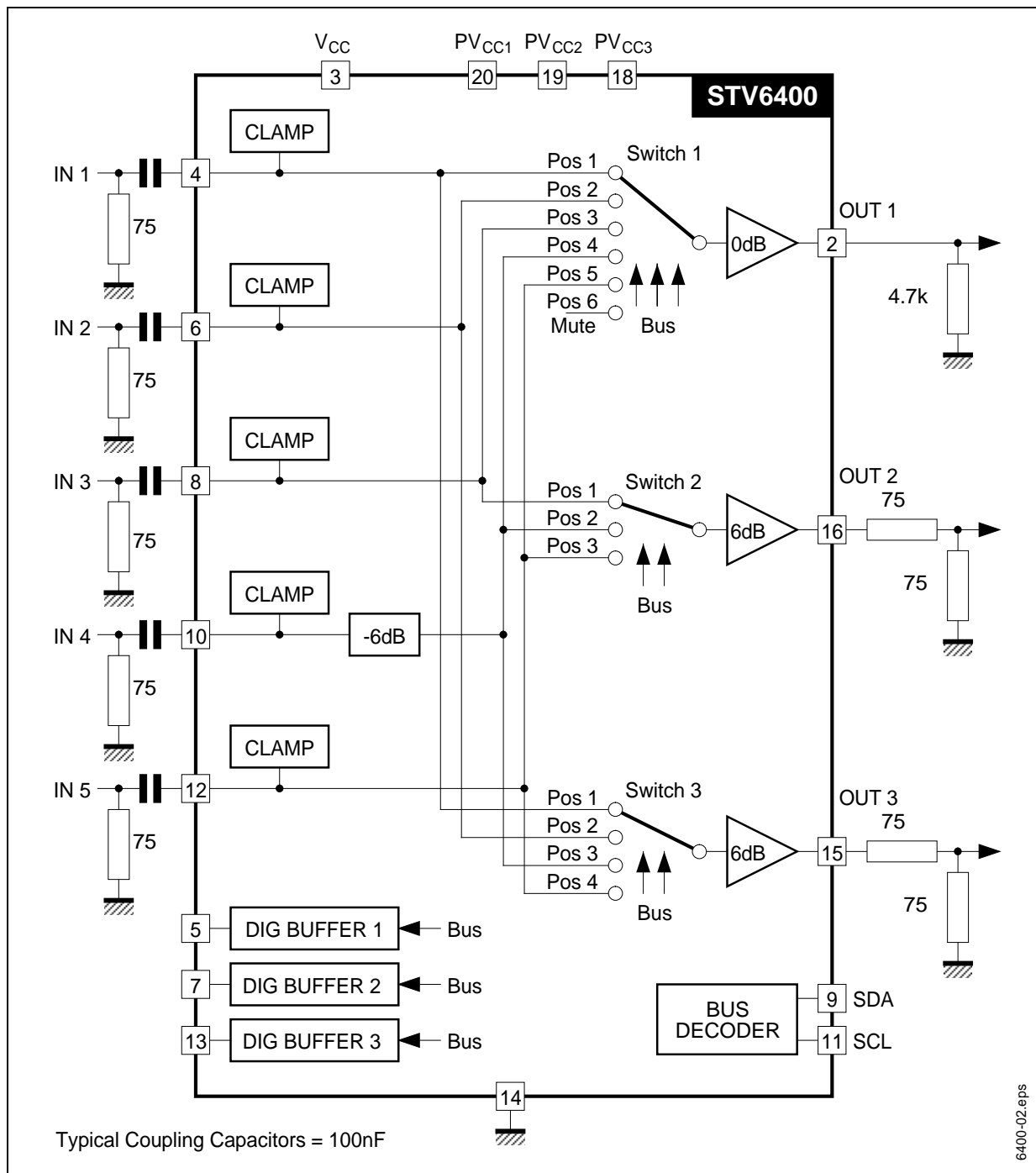


**Figure 1. PIN CONNECTIONS**



# STV6400

Figure 2. BLOCK DIAGRAM



## ABSOLUTE MAXIMUM RATINGS

Symbol	Parameter	Value	Unit
$V_{CC}$	Supply Voltage	12.0	V
$T_{oper}$	Operating Temperature	-10, + 70	°C
$T_{stg}$	Storage Temperature	-55, + 150	°C

## THERMAL DATA

Symbol	Parameter	Value	Unit	
$R_{th(j-a)}$	Junction-ambient Thermal Resistance	DIP20	70	°C/W
		SO20	100	°C/W

## DC AND AC ELECTRICAL CHARACTERISTICS

$V_{CC} = 5V$ ,  $T_{amb} = 25^{\circ}C$  (Unless otherwise specified)

$R_{LOAD\ OUT\ 1} = 4.7k\Omega$ ,  $R_{LOAD\ OUT2\ OUT3} = 150\Omega$ ,  $V_{IN} = 1V_{PP}$

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
$V_{CC}$	Operating Supply Voltage		4, 75	5	11.0	V
$I_{CC}$	Supply Current	Without loads		27	40	mA
$Svr$	Supply Voltage Rejection	1kHz		-36		dB
VIDEO INPUTS						
$V_{DCIN}$	DC Input Voltage (black level)			1, 4	4	V
$I_{LCAK}$	Leakage Current Input			1	3	$\mu A$
CAPIN	Input Capacitance			5		pF
$V_{IN0}$	Input Signal Amplitude	Video 4			2.5	$V_{PP}$
$V_{IN6}$	Input Signal Amplitude	Video 1 2 3 5			1.5	$V_{PP}$
VIDEO OUTPUTS						
DYN	Dynamic Output Signal (out 1)	$V_{CC} = 5V$	2, 5			$V_{PP}$
DYN	Dynamic Output Signal (out 1)	$V_{CC} = 4.75V$	2, 3			$V_{PP}$
DYN	Dynamic Output Signal (out 2, 3)	$V_{CC} = 5V$	3			$V_{PP}$
		$V_{CC} = 4.75V$	2.8			$V_{PP}$
BW0	0dB Gain Bandwidth at -3dB	$V_{IN} = 1V_{PP}$	10	23		MHZ
BW6	6dB Gain Bandwidth at -3dB	$V_{IN} = 1V_{PP}$	10	19		MHZ
CT*	Crosstalk between Input 1, 2, 3, 5 and Output 2, 3	$V_{IN} = 1V_{PP}$ , $f = 5MHz$		-62	-53	dB
CT*	Crosstalk between Input 4, and Output 2, 3	$V_{IN4} = 2V_{PP}$ , $f = 5MHz$		-60	-52	dB
CT*	Crosstalk between Input 1, 2, 3, 5 and Output 1	$V_{IN} = 1V_{PP}$ , $f = 5MHz$		-60	-55	dB
CT*	Crosstalk between Input 4 and Output 1	$V_{IN4} = 2V_{PP}$ , $f = 5MHz$		-53	-50	dB
$Z_{OUT}$	Output Impedance			4	10	W
$G_0$	0dB Gain		-0.5	0	+0.5	dB
$G_6$	6dB Gain		5.5	6	6.5	dB
DCOUT	DC Output Voltage			0.7		V
DPH10	Differential Phase 0dB Output	$V_{IN} = 1V_{PP}$		0.25		
DPH6	Differential Phase 6dB Output	$V_{IN} = 1V_{PP}$		0.5		
DGAIN0	Differential Gain 0dB Output	$V_{IN} = 1V_{PP}$		1.5		%
DGAIN6	Differential Gain 6dB Output	$V_{IN} = 1V_{PP}$		1.8		%
MUTE	Muting Suppression at Output 1	$V_{IN} = 1V_{PP}$ , $f = 5MHz$		-50	-45	dB
DIGITAL BUFFERS						
$V_{OL}$	Low Level Output Voltage	$I = 3\text{ mA}$			0, 4	V
$Z_{OUT}$	Output Resistance at High Level			30		k $\Omega$
DCMAX	Max DC Voltage				$V_{CC}$	V

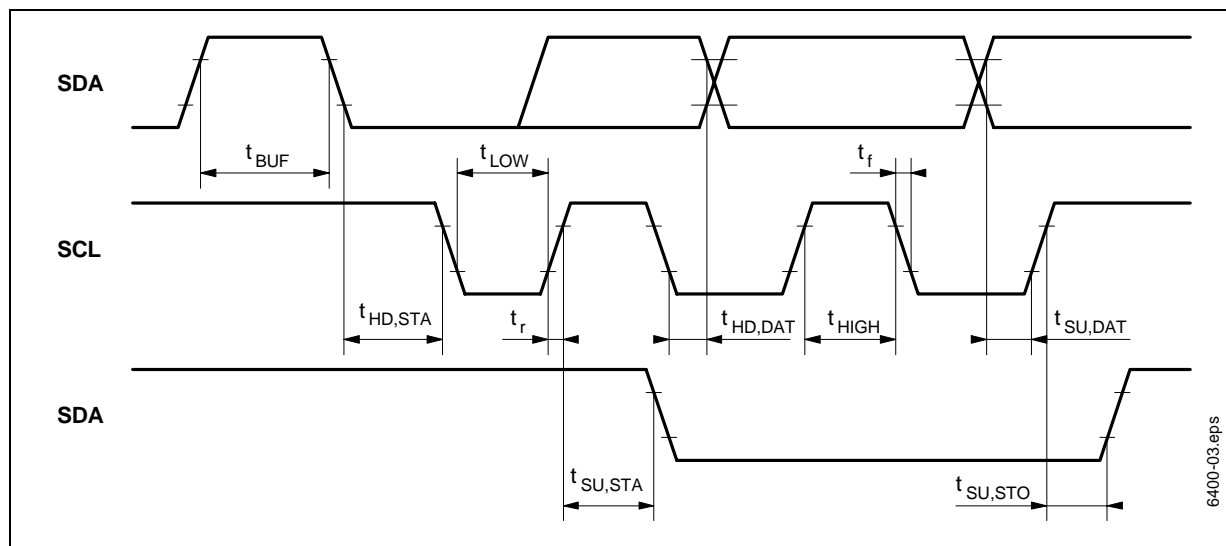
\* DIP20 package.

# STV6400

## I<sup>2</sup>C BUS CHARACTERISTICS

Symbol	Parameter	Test Conditions	Min.	Max.	Unit
<b>SCL</b>					
V <sub>IL</sub>	Low Level Input Voltage		- 0.3	+ 1.5	V
V <sub>IH</sub>	High Level Input Voltage		3.0	V <sub>CC</sub> + 0.5	V
I <sub>LI</sub>	Input Leakage Current	V <sub>I</sub> = 0 to V <sub>CC</sub>	- 10	+ 10	μA
f <sub>SCL</sub>	Clock Frequency		0	100	kHz
t <sub>R</sub>	Input Rise Time	1.5V to 3V		1000	ns
t <sub>F</sub>	Input Fall Time	1.5V to 3V		300	ns
C <sub>I</sub>	Input Capacitance			10	pF
<b>SDA</b>					
V <sub>IL</sub>	Low Level Input Voltage		- 0.3	+ 1.5	V
V <sub>IH</sub>	High Level Input Voltage		3.0	V <sub>CC</sub> + 0.5	V
I <sub>LI</sub>	Input Leakage Current	V <sub>I</sub> = 0 to V <sub>CC</sub>	- 10	+ 10	μA
C <sub>I</sub>	Input Capacitance			10	pF
t <sub>R</sub>	Input Rise Time	1.5V to 3V		1000	ns
t <sub>F</sub>	Input Fall Time	1.5V to 3V		300	ns
V <sub>OL</sub>	Low Level Output Voltage	I <sub>OL</sub> = 3mA		0.4	V
t <sub>F</sub>	Output Fall Time	3V to 1.5V		250	ns
C <sub>L</sub>	Load Capacitance			400	pF
<b>TIMING</b>					
t <sub>LOW</sub>	Clock Low Period		4.7		μs
t <sub>HIGH</sub>	Clock High Period		4.0		μs
t <sub>SU, DAT</sub>	Data Set-up Time		250		ns
t <sub>HD, DAT</sub>	Data Hold Time		0	340	ns
t <sub>SU, STO</sub>	Set-up Time from Clock High to Stop		4.0		μs
t <sub>BUF</sub>	Start Set-up Time following a Stop		4.7		μs
t <sub>HD, STA</sub>	Start Hold Time		4.0		μs
t <sub>SU, STA</sub>	Start Set-up Time following Clock Low-to High Transition		4.7		μs

Figure 3. I<sup>2</sup>C Bus Timing



**SOFTWARE SPECIFICATION**I<sup>2</sup>C Address Byte

92 HEXA

DATA BYTE

B7	B6	B5	B4	B3	B2	B1	B0	
X	X	0	0		0 0 0 0 1 1 1 1	0 0 1 1 0 0 1 1	0 1 0 1 0 1 0 1	SWITCH 1 POSITION 1 VIDEO IN 1 POSITION 2 VIDEO IN 2 POSITION 3 VIDEO IN 3 POSITION 4 VIDEO IN 4 POSITION 5 VIDEO IN 5 POSITION 6 MUTE NOT ALLOWED NOT ALLOWED
X	X	0	1		X X X X	0 0 1 1	0 1 0 1	SWITCH 2 POSITION 1 VIDEO IN 3 POSITION 2 VIDEO IN 4 POSITION 3 VIDEO IN 5 NOT ALLOWED
X	X	1	0		X X X X	0 0 1 1	0 1 0 1	SWITCH 2 POSITION 1 VIDEO IN 1 POSITION 2 VIDEO IN 2 POSITION 3 VIDEO IN 4 POSITION 4 VIDEO IN 5
X	X	1	1		X X 1/0	X 1/0 X	1/0 X X	DIGITAL BUFFER DIG BUFFER 1 DIG BUFFER 2 DIG BUFFER 3

**Remark :** The letter "X" means don't care.

**Example :** XX00X100 means.

The switch 1 is connected to Video input 5

Example : XX11X011 means.

Digital buffer 1 is at high level  
Digital buffer 2 is at high level  
Digital buffer 3 is at low level

The starting condition upon power-on is undetermined.

In this case 4 words of 16 bits are necessary to fix the device configuration.

In other case only one word of 16 bits is necessary to modify one configuration of the device.

# STV6400

## INPUT/OUTPUT PIN CONFIGURATION

Figure 4.

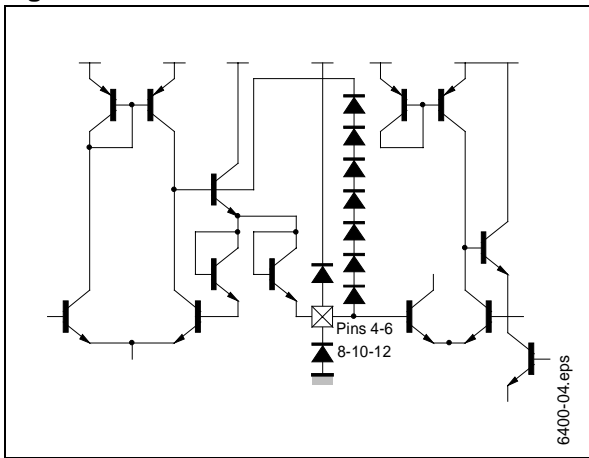


Figure 5.

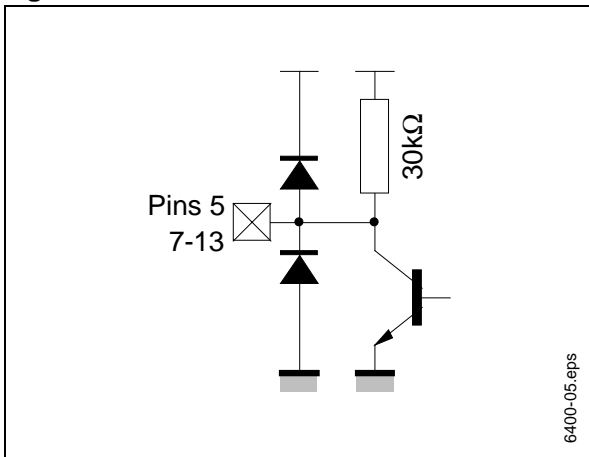


Figure 6.

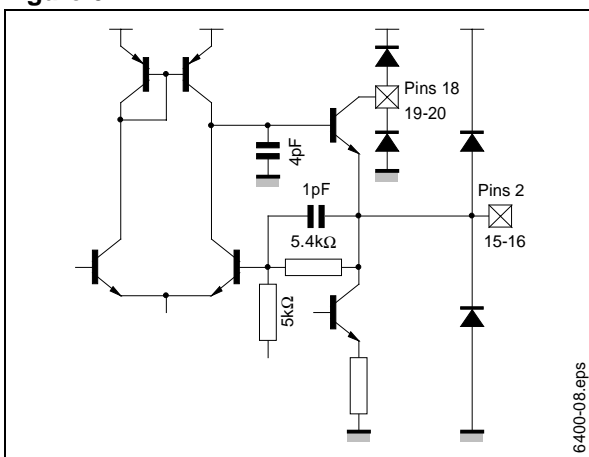


Figure 7.

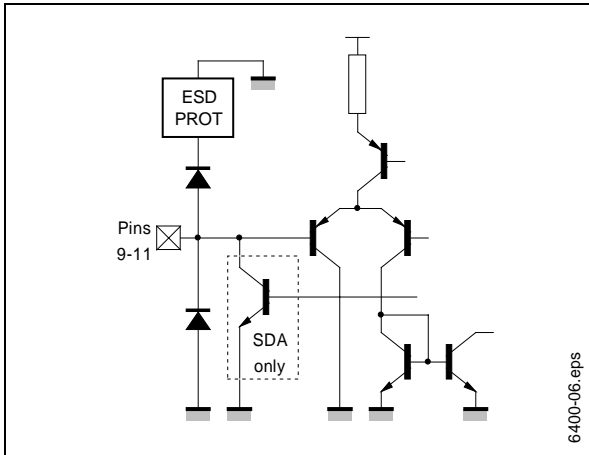
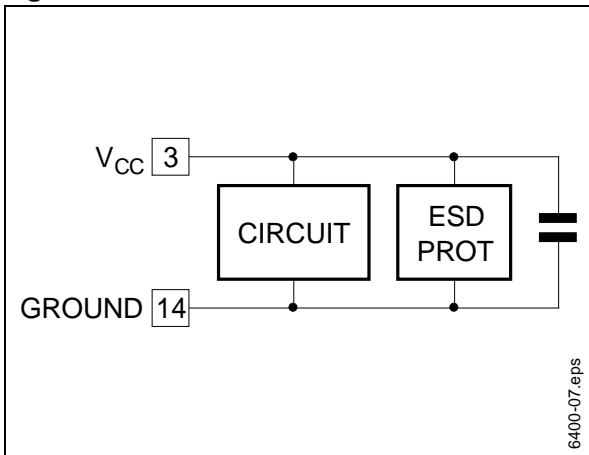


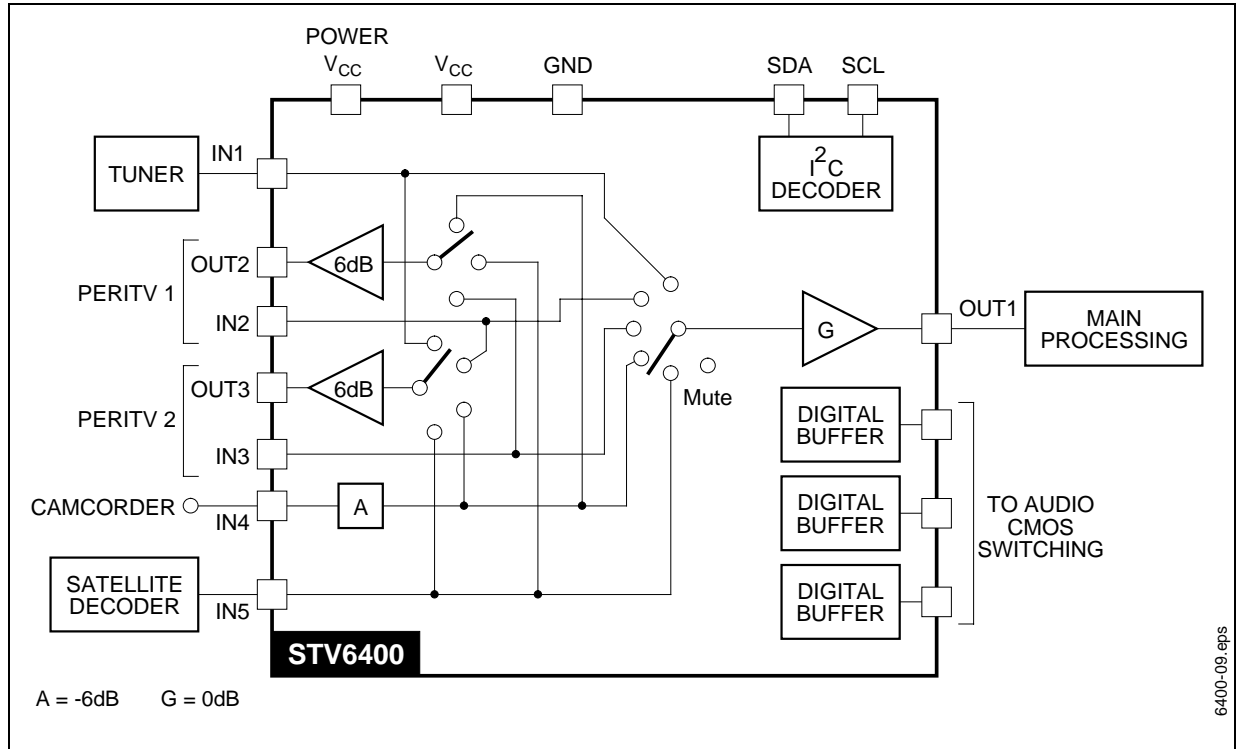
Figure 8.



# STV6400

## TYPICAL APPLICATION

Figure 9.





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